TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX32F,TC74LCX32FN,TC74LCX32FT

Low-Voltage Quad 2-Input OR Gate with 5-V Tolerant Inputs and Outputs

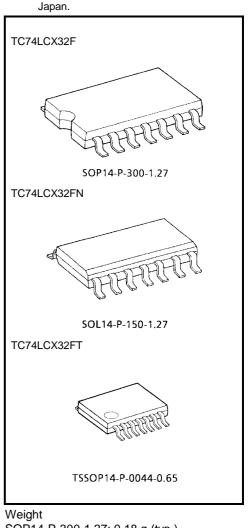
The TC74LCX32F/FN/FT is a high-performance CMOS 2-input OR gate. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

The device is designed for low-voltage $(3.3 \text{ V}) \text{ V}_{CC}$ applications, but it could be used to interface to 5-V supply environment for inputs.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: $V_{CC} = 2.0$ to 3.6 V
- High-speed operation: $t_{pd} = 5.5 \text{ ns} (max) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA} (\text{min}) (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 32 type

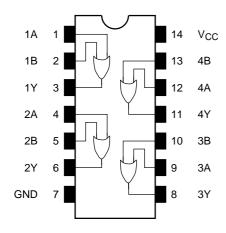


Note: xxxFN (JEDEC SOP) is not available in

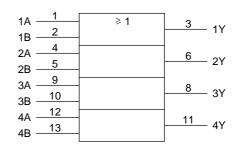
SOP14-P-300-1.27: 0.18 g (typ.) SOL14-P-150-1.27: 0.12 g (typ.) TSSOP14-P-0044-0.65: 0.06 g (typ.)

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Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inp	uts	Outputs		
А	В	Y		
L	L	L		
L H		н		
Н	L	н		
Н	Н	н		

Maximum Ratings

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CC}	-0.5 to 7.0	V	
DC input voltage	V _{IN}	-0.5 to 7.0	V	
		-0.5 to 7.0 (Note 1)		
DC output voltage	V _{OUT}	-0.5 to $V_{\mbox{CC}}+0.5$	V	
		(Note 2)		
Input diode current	I _{IK}	-50	mA	
Output diode current	I _{OK}	±50 (Note 3)	mA	
DC output current	IOUT	±50	mA	
Power dissipation	PD	180	mW	
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA	
Storage temperature	T _{stg}	-65 to 150	°C	

Note 1: $V_{CC} = 0 V$

Note 2: High or low state. IOUT absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CC}	2.0 to 3.6	V	
Tower supply voltage	vcc	1.5 to 3.6 (Note 4)	v	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 5)	V	
Output voltage	VOUT	0 to V _{CC} (Note 6)		
Output current	lau/lau	±24 (Note 7)	mA	
Output current	I _{OH} /I _{OL}	±12 (Note 8)	ma	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V	

Note 4: Data retention only

Note 5: $V_{CC} = 0 V$

Note 6: High or low state

Note 7: $V_{CC} = 3.0$ to 3.6 V

Note 8: $V_{CC} = 2.7$ to 3.0 V

Note 9: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristi	CS	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
	H-level	VIH				2.0	_	V
Input voltage	L-level	VIL			2.7 to 3.6		0.8	v
				I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	_	V
	H-level	Vон	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				I _{OH} = -18 mA	3.0	2.4	_	
Output voltage				I _{OH} = -24 mA	3.0	2.2	_	
L-level		-level V _{OL}	V _{IN} = V _{IL}	$I_{OL} = 100 \ \mu A$	2.7 to 3.6	_	0.2	
				$I_{OL} = 12 \text{ mA}$	2.7	_	0.4	
	L-level			I _{OL} = 16 mA	3.0	_	0.4	
				$I_{OL} = 24 \text{ mA}$	3.0		0.55	
Input leakage current	t I_{IN} $V_{IN} = 0$ to 5.5 V		2.7 to 3.6	_	±5.0	μA		
Power-off leakage curr	ent	I _{OFF}	$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μA
		Icc	$V_{IN} = V_{CC} \text{ or } GND$		2.7 to 3.6	_	10.0	
Quiescent supply current	V _{IN} = 3.6 to 5.5 V		2.7 to 3.6		±10.0	μA		
Increase in Icc per inpu	ut	Δlcc	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6	_	500	

AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.7	_	6.2	ns
	t _{pHL}		$\textbf{3.3}\pm\textbf{0.3}$	1.5	5.5	
Output to output skew	t _{osLH}	(Note 10)	2.7	_	_	ns
	t _{osHL}		$\textbf{3.3}\pm\textbf{0.3}$	—	1.0	115

Note 10: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$

Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	ſ	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_		3.3	7	pF
Output capacitance	C _{OUT}	_		0	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (No	ote 11)	3.3	25	pF

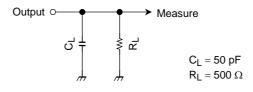
Note 11: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$ (per gate)

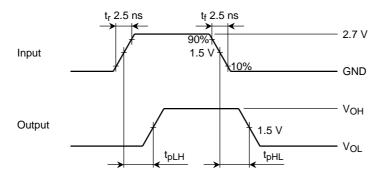
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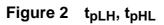
AC Test Circuit



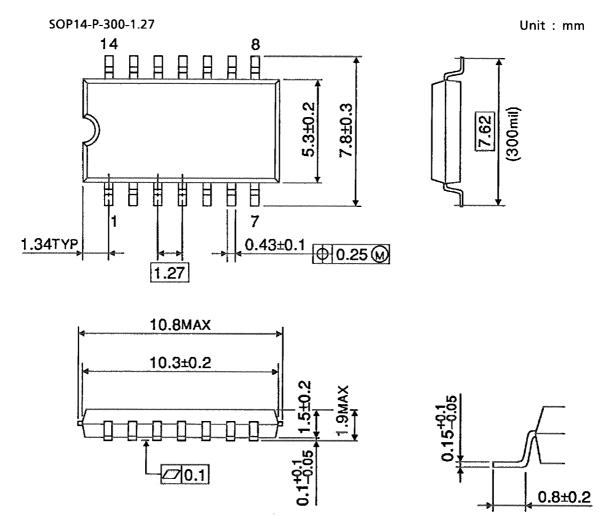


AC Waveform



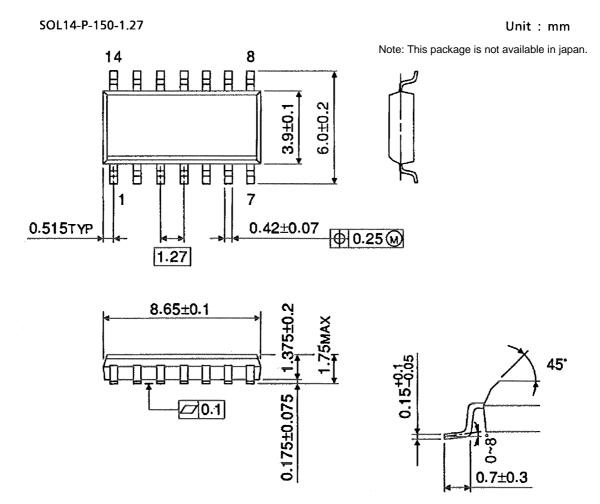


Package Dimensions



Weight: 0.18 g (typ.)

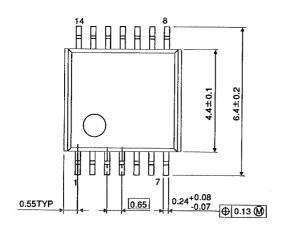
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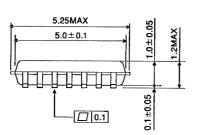
Weight: 0.12 g (typ.)

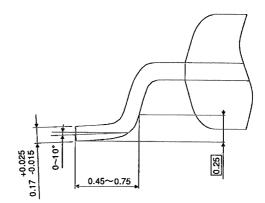
Package Dimensions

TSSOP14-P-0044-0.65









Weight: 0.06 g (typ.)

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